TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π-MOSV)

2SK2920

Chopper Regulator, DC-DC Converter and Motor Drive Applications

• 4 V gate drive

• Low drain–source ON resistance $: R_{DS} (ON) = 0.56 \Omega (typ.)$ • High forward transfer admittance $: |Y_{fs}| = 4.5 S (typ.)$ • Low leakage current $: I_{DSS} = 100 \mu A (max) (V_{DS} = 200 V)$ • Enhancement–mode $: V_{th} = 1.5 \sim 3.5 V (V_{DS} = 10 V, I_{D} = 1 mA)$

Maximum Ratings (Ta = 25°C)

Characteristics			Symbol	Rating	Unit	
Drain-source voltage			V_{DSS}	200	V	
Drain-gate voltage (R _{GS} = 20 kΩ)			V_{DGR}	200	V	
Gate-source voltage			V _{GSS}	±20	V	
Drain current	DC (I	Note 1)	I _D	5	Α	
	Pulse (Note 1)		I _{DP}	20	Α	
Drain power dissipation (Tc = 25°C)			P _D	20	W	
Single pulse avalanche energy (Note 2)			E _{AS}	65	mJ	
Avalanche current			I _{AR}	5	Α	
Repetitive avalanche energy (Note 3)			E _{AR}	2	mJ	
Channel temperature			T _{ch}	150	°C	
Storage temperature range			T _{stg}	-55~150	°C	

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R _{th (ch-c)}	6.25	°C/W
Thermal resistance, channel to ambient	R _{th (ch-a)}	125	°C/W

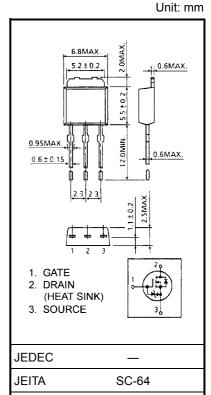
Note 1: Please use devices on condition that the channel temperature is below 150°C.

Note 2: V_{DD} = 50 V, T_{ch} = 25°C (initial), L = 4.2 mH, R_G = 25 Ω , I_{AR} = 5 A

Note 3: Repetitive rating: Pulse width limited by maximum channel temperature

This transistor is an electrostatic sensitive device.

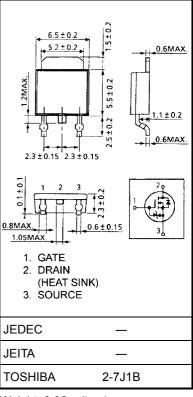
Please handle with caution.



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Weight: 0.36 g (typ.)

TOSHIBA



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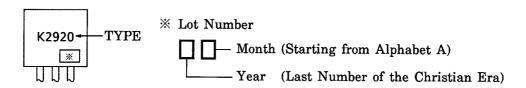
Electrical Characteristics (Ta = 25°C)

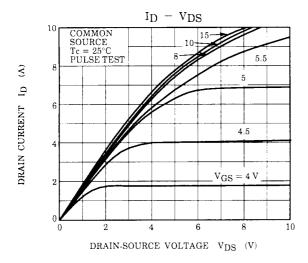
Charac	eteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	rrent	I _{GSS}	V _{GS} = ±16 V, V _{DS} = 0 V	_	_	±10	μΑ
Drain cut-off cu	rrent	I _{DSS}	V _{DS} = 200 V, V _{GS} = 0 V	_	_	100	μΑ
Drain-source br	eakdown voltage	V (BR) DSS	I _D = 10 mA, V _{GS} = 0 V	200	_	_	V
Gate threshold v	voltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	1.5	_	3.5	V
Drain-source O	N resistance	R _{DS (ON)}	V _{GS} = 10 V, I _D = 2.5 A	_	0.56	0.8	Ω
Forward transfer	admittance	Y _{fs}	V _{DS} = 10 V, I _D = 2.5 A	2.0	4.5	_	S
Input capacitano	:e	C _{iss}		_	440	_	
Reverse transfer	everse transfer capacitance C_{rss} $V_{DS} = 10 \text{ V}, V_{GS} = 0$		V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	_	35	_	рF
Output capacita	nce	C _{oss}			120	_	
Switching time Fall time	Rise time	t _r	V_{GS} 0 V_{Out} $R_{L} = 40 \Omega$	_	15	_	
	Turn-on time	t _{on}		_	20	_	
	Fall time	t _f	$\begin{array}{c c} & & \\ & &$	_	15	_	ns
	Turn-off time	t _{off}	Duty \leq 1%, $t_{\mathbf{w}} = 10 \mu s$	_	60	_	
Total gate charge (gate-source plus gate-drain)		Qg			10	_	
Gate-source charge		Q _{gs}	$V_{DD} \approx 100 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 5 \text{ A}$		6		nC
Gate-drain ("miller") Charge		Q_{gd}			4	_	

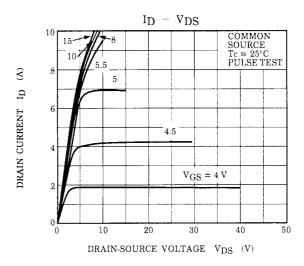
Source-Drain Ratings and Characteristics (Ta = 25°C)

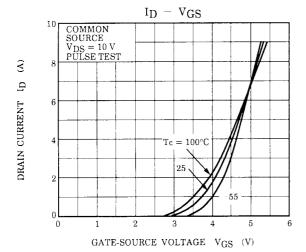
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}		_	_	5	Α
Pulse drain reverse current (Note 1)	I _{DRP}	-	_	_	20	Α
Forward voltage (diode)	V _{DSF}	I _{DR} = 5 A, V _{GS} = 0 V	_	_	-2.0	V
Reverse recovery time	t _{rr}	I_{DR} = 5 A, V_{GS} = 0 V, dI_{DR} / dt = 100 A / μ s	1	150	-	ns
Reverse recovery charge	Q _{rr}		_	0.45	_	μC

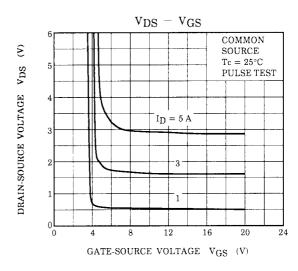
Marking

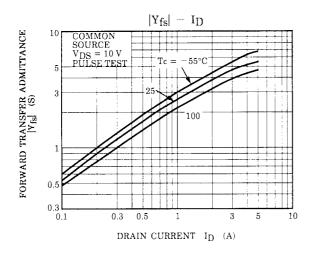


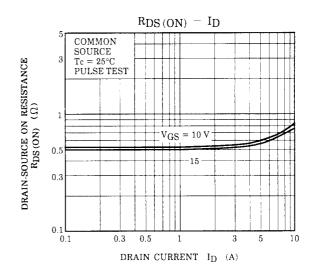




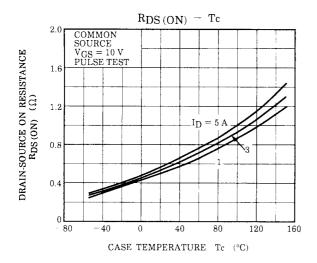


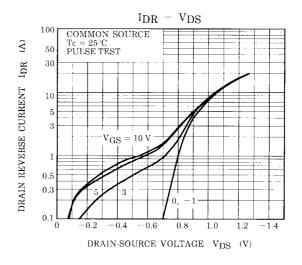


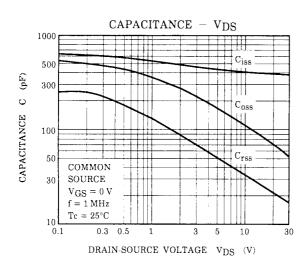


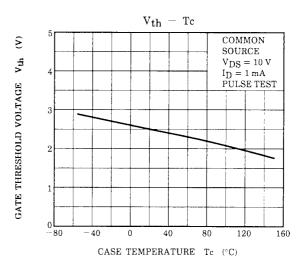


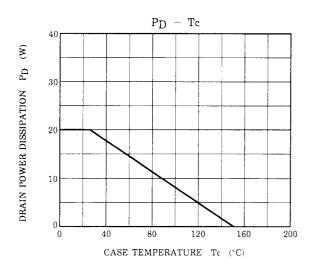
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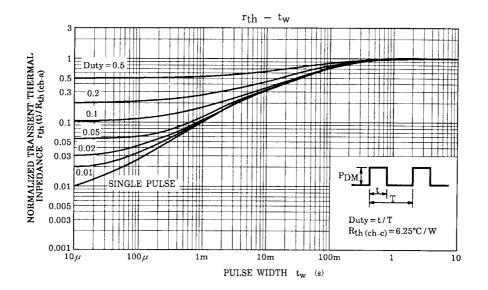


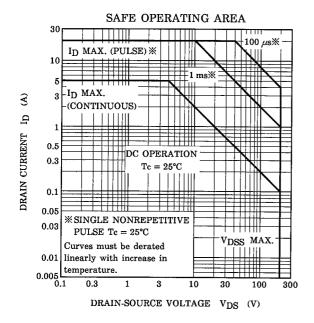


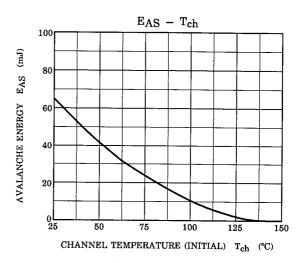


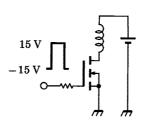


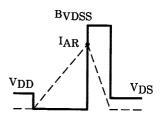
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TEST CIRCUIT

 R_G = 25 Ω V_{DD} = 25 V, L = 4.2 mH

$$\begin{aligned} & \textbf{WAVE FORM} \\ & E_{AS} = \frac{1}{2} \cdot L \cdot I^2 \cdot \left(\frac{B_{VDSS}}{B_{VDSS} - V_{DD}} \right) \end{aligned}$$

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